

60V NPN SMALL SIGNAL TRANSISTOR IN SOT323

Features

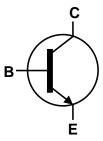
- BV_{CEO} > 40V
- I_C = 200mA Collector Current
- Epitaxial Planar Die Construction
- Ultra-Small Surface Mount Package
- Complementary PNP Type: MMST3906
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

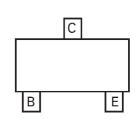
- Case: SOT323
- Case Material: Molded Plastic. "Green" Molding Compound.
 UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.006 grams (Approximate)







Device Symbol



Pin-out Top View

July 2016

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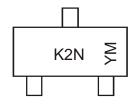
Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
MMST3904-7-F	AEC-Q101	K2N	7	8	3,000
MMST3904Q-7-F	Automotive	K2N	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/product_compliance_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



$$\begin{split} &K2N = Product\ Type\ Marking\ Code \\ &YM = Date\ Code\ Marking \\ &Y\ or\ \overline{Y} = Year\ (ex:\ D=2016) \\ &M\ or\ \overline{M} = Month\ (ex:\ 9=September) \end{split}$$

Date Code Key

Year	2016	3 2	2017	2018	2019	2020	2021	2022	2 20	23 2	2024	2025	2026
Code	D		E	F	G	Н	I	J	ŀ	(L	М	N
Month	1	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code)	1	2	3	4	5	6	7	8	9	0	N	D



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	60	V
Collector-Emitter Voltage	V_{CEO}	40	V
Emitter-Base Voltage	V_{EBO}	6	V
Collector Current	Ic	200	mA

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	200	mW
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

ESD Ratings (Note 7)

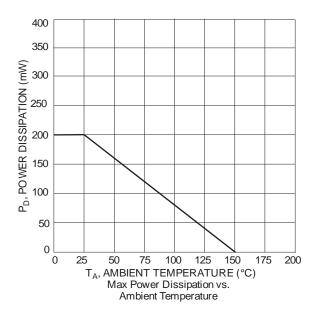
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 6. For a device mounted with the collector lead on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.

^{7.} Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





Electrical Characteristics ($@T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)					
Collector-Base Breakdown Voltage	BV _{CBO}	60	_	V	$I_C = 10\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage	BV _{CEO}	40	_	V	$I_C = 1 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	5	_	V	$I_E = 10\mu A, I_C = 0$
Collector Cutoff Current	I _{CEX}	_	50	nA	$V_{CE} = 30V$, $V_{EB(OFF)} = 3V$
Base Cutoff Current	I _{BL}	_	50	nA	$V_{CE} = 30V$, $V_{EB(OFF)} = 3V$
ON CHARACTERISTICS (Note 8)					
		40			$I_C = 100 \mu A$, $V_{CE} = 1 V$
		70	_		$I_C = 1mA$, $V_{CE} = 1V$
DC Current Gain	h _{FE}	100	300	_	$I_C = 10mA$, $V_{CE} = 1V$
		60	_		$I_C = 50$ mA, $V_{CE} = 1$ V
		30	—		$I_C = 100 \text{mA}, V_{CE} = 1 \text{V}$
Collector-Emitter Saturation Voltage	V		0.25	V	$I_C = 10mA$, $I_B = 1mA$
Collector-Emilier Saturation voltage	V _{CE(SAT)}		0.30	V	$I_C = 50 \text{mA}, I_B = 5 \text{mA}$
Base-Emitter Saturation Voltage	\/	0.65	0.85	V	$I_C = 10mA$, $I_B = 1mA$
ŭ	V _{BE} (SAT)	—	0.95	V	$I_C = 50 \text{mA}, I_B = 5 \text{mA}$
SMALL SIGNAL CHARACTERISTICS		•	,		
Output Capacitance	$C_{ m obo}$	_	4	pF	$V_{CB} = 5V$, $f = 1.0MHz$, $I_E = 0$
Input Capacitance	C _{ibo}	_	8	pF	$V_{EB} = 0.5V$, $f = 1.0MHz$, $I_{C} = 0$
Input Impedance	h _{ie}	1	10	kΩ	
Voltage Feedback Ratio	h _{re}	0.5	8.0	x 10 ⁻⁴	$V_{CE} = 10V, I_{C} = 1mA,$
Small Signal Current Gain	h _{fe}	100	400	_	f = 1.0MHz
Output Admittance	h _{oe}	1	40	μS	
Current Gain-Bandwidth Product	f _T	300	_	MHz	$V_{CE} = 20V, I_{C} = 10mA,$ f = 100MHz
Noise Figure	NF		5	dB	$V_{CC} = 5V, I_C = 100\mu A,$ $R_S = 1k\Omega, f = 1MHz$
SWITCHING CHARACTERISTICS	•	•	•	•	
Delay Time	t _D	_	35	ns	$V_{CC} = 3V$, $I_C = 10mA$,
Rise Time	t _R		35	ns	$V_{BE(OFF)} = -0.5V$, $I_{B1} = 1mA$

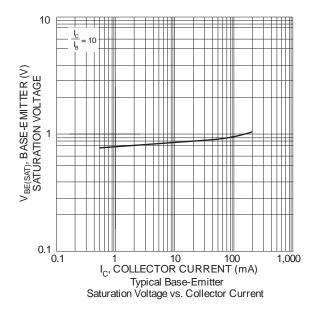
Notes: 8. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.

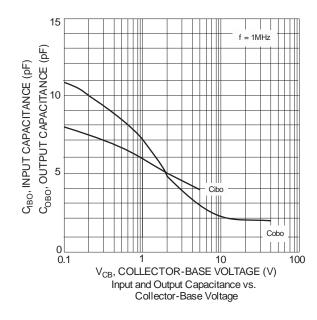
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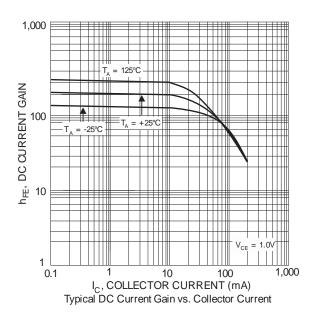
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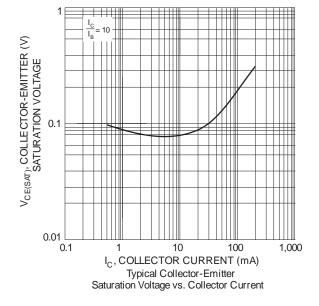


Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)







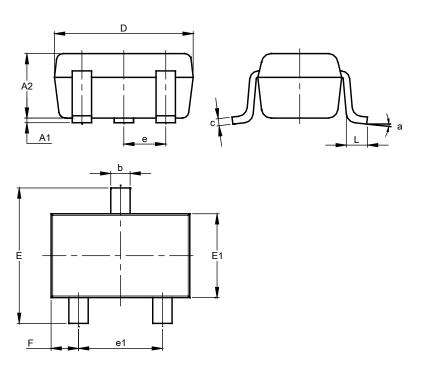




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323

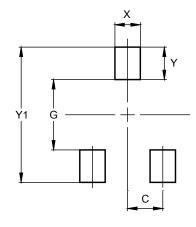


SOT323						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.25	0.40	0.30			
С	0.10	0.18	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	C	0.650 BSC				
e1	1.20	1.40	1.30			
F	0.375	0.475	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323



Dimensions	Value (in mm)
С	0.650
G	1.300
X	0.470
Y	0.600
Y1	2.500



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